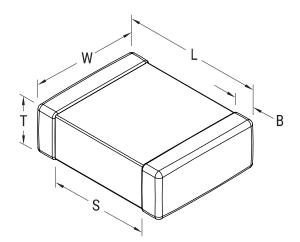


C1210X182M2TAC7210

SMD Comm X8G HT150C Flex, Ceramic, 1,800 pF, 20%, 200 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1210, 1.5 mm



Click here for the 3D model.

General Information		
Series	SMD Comm X8G HT150C Flex	
Style	SMD Chip	
Description	SMD, MLCC, High Temperature, Ultra-Stable	
Features	High Temperature, Ultra-Stable	
RoHS	Yes	
Termination	Flexible Termination	
Marking	No	
AEC-Q200	No	
Typical Component Weight	40 mg	
Shelf Life	78 Weeks	
MSL	1	

0.1% 1 kHz 1.0Vrms

100 GOhms

0% Loss/Decade Hour: Referee Time is 1000 Hours

		Specifications	
	1210	Capacitance	1,800 pF
	3.3mm +/-0.4mm	Measurement Condition	1 kHz 1.0Vrms
	2.6mm +/-0.3mm	Tolerance	20%
	1mm +/-0.10mm	Voltage DC	200 VDC
	1.5mm MIN	Dielectric Withstanding Voltage	500 VDC
	0.6mm +/-0.25mm	Temperature Range	-55/+150°C
		Temp. Coefficient	X8G
ns		Capacitance Change with	30 ppm/C, 1kHz 1.0Vrms
	T&R, 330mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	
	10000		

Dissipation Factor

Insulation Resistance

Aging Rate

Dimensions Chip Size L W Т s в

Packaging Specification Packaging

Packaging Quantity 10000